

50Ω to 150Ω Balanced

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Ultra Low Profile 0805 Balun



### **Description:**

The BD0810J50150AHF is a low profile sub-miniature balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering the GSM frequency. The BD0810J50150AHF is ideal for high volume manufacturing and is higher performance than traditional ceramic, and lumped element baluns. The BD0810J50150AHF has an unbalanced port impedance of  $50\Omega$  and a  $150\Omega$  balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern semiconductors. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD0810J50150AHF is available on tape and reel for pick and place high volume manufacturing.

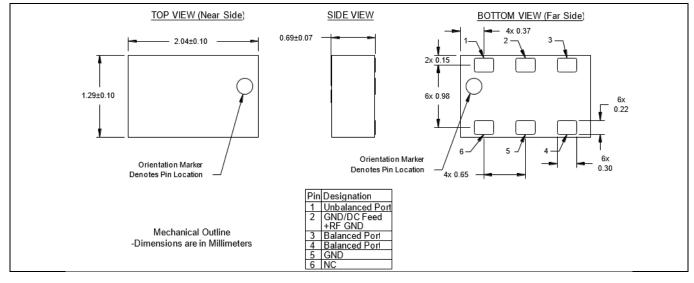
# **Detailed Electrical Specifications:**

Specifications subject to change without notice.

		ROOM (25°C)			
<u>Features:</u>	Parameter	Min.	Тур.	Max	Unit
• 800 – 1000 MHz	Frequency	800		1000	MHz
<ul> <li>0.7mm Height Profile</li> <li>50 Ohm to 2 x 75 Ohm</li> </ul>	Unbalanced Port Impedance		50		Ω
• GSM	Balanced Port Impedance		150		Ω
Low Insertion Loss	Return Loss	13.3	19.6		dB
Input to Output DC Isolation	Insertion Loss*		0.9	1.1	dB
Surface Mountable	Amplitude Balance		0.2	0.6	dB
Tape & Reel	Phase Balance		2.5	6	Degrees
<ul><li>Non-conductive Surface</li><li>RoHS Compliant</li></ul>	CMRR		33		dB
Halogen Free	Power Handling			2	Watts
	Operating Temperature	-55		+85	°C

\*Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

### **Outline Drawing:**



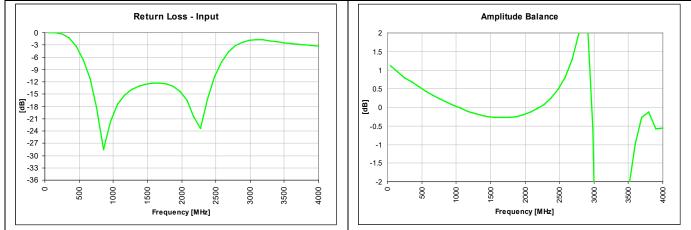
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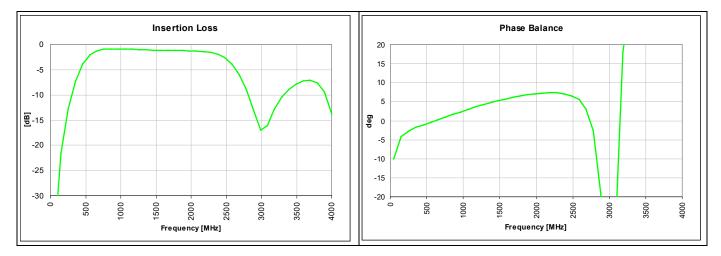
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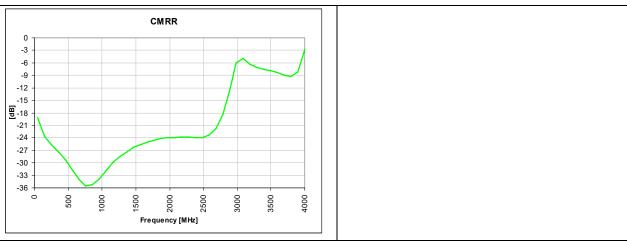


BD0810J50150AHF Rev D

## Wide Band Performance: 0 GHz. to 4.0 GHz.







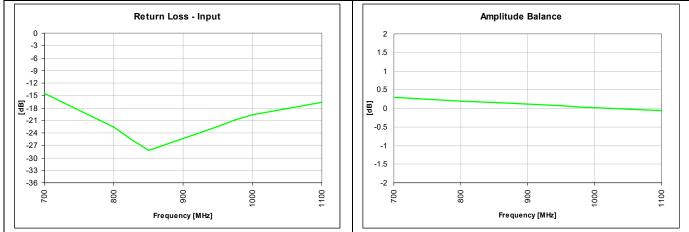
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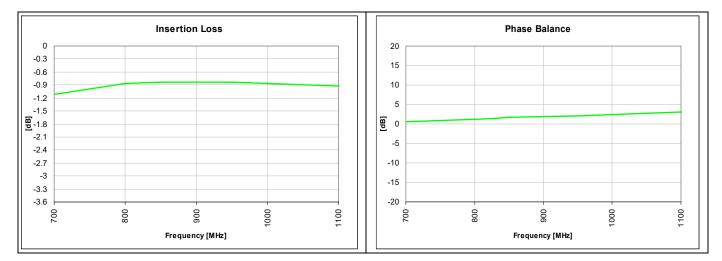
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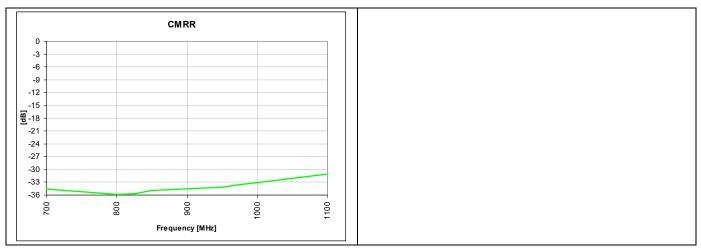


BD0810J50150AHF Rev D

# Typical Performance: 700 MHz. to 1100 MHz.







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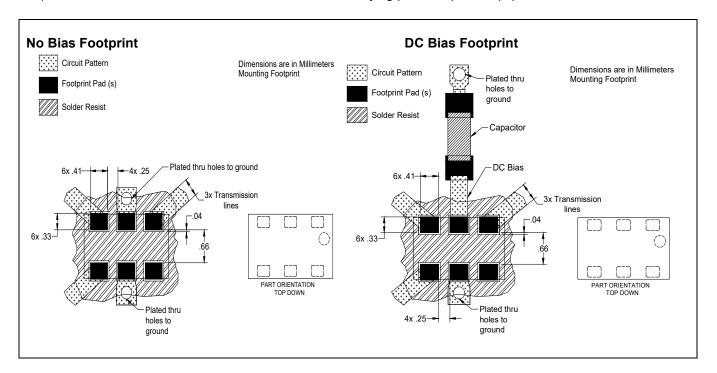


#### **Mounting Configuration:**

In order for Xinger surface mount components to work optimally, the proper impedance transmission lines must be used to connect to the RF ports. If this condition is not satisfied, insertionloss, Isolation and Vswr may not meet published specifications.

All of the Xinger components are constructed from organic PTFE based composites which possess excellent electrical and mechanical stability. Xinger components are compliant to a variety of ROHS and Green standards and ready for Pb-free soldering processes. Pads are Gold plated with Nickel barrier.

An example of the PCB footprint used in the testing of these parts is shown below. An example of a DC-biased footprint is also shown below. In specific designs, the transmission line widths need to be adjusted to the unique dielectric coefficients and thicknesses as well as varying pick and place equipment tolerances.



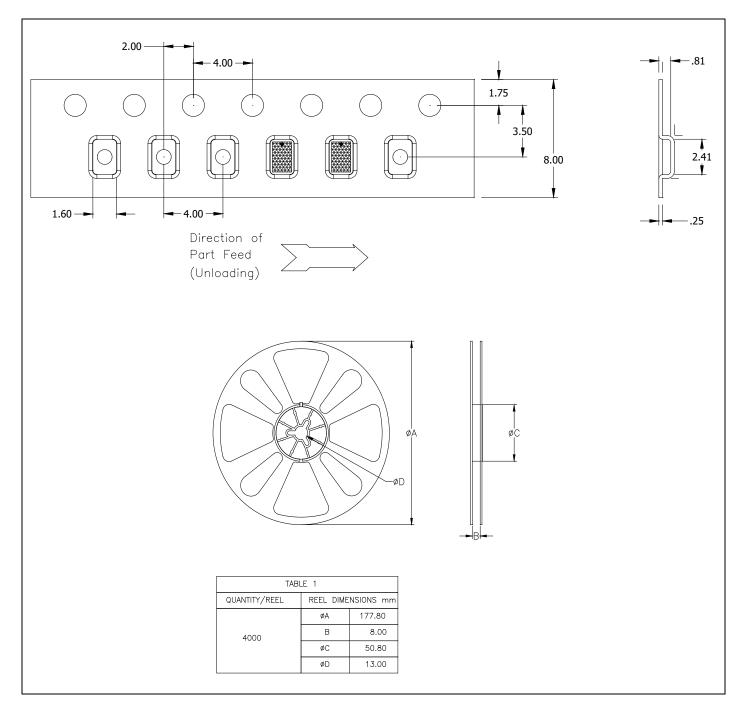
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#### Packaging and Ordering Information:

Parts are available in reel and are packaged per EIA 481-2. Parts are oriented in tape and reel as shown below. Minimum order quantities are 4000 per reel. See Model Numbers below for further ordering information.



Contact us: rf&s support@ttm.com

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